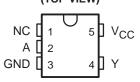
- EPIC[™] (Enhanced-Performance Implanted CMOS) Process
- Operating Range 2-V to 5.5-V V_{CC}
- Unbuffered Output
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline Transistor (DBV, DCK) Packages

DBV OR DCK PACKAGE (TOP VIEW)



NC - No internal connection

description

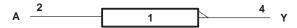
The SN74AHC1GU04 contains a single inverter gate. The device performs the Boolean function $Y = \overline{A}$. Internal circuitry consists of a single-stage inverter that can be used in analog applications, such as crystal oscillators.

The SN74AHC1GU04 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE

INPUT A	OUTPUT Y
Н	L
L	Н

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to 7 V
Output voltage range, V _O (see Note 1)	0.5 V to V _{CC} + 0.5 V
Input clamp current, I _{IK} (V _I < 0)	–20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±20 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): DBV package	347°C/W
DCK package	389°C/W
Storage temperature range, T _{sto}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions

			MIN	MAX	UNIT
Vcc	Supply voltage		2	5.5	V
		V _{CC} = 2 V	1.7		
VIH	High-level input voltage	V _{CC} = 3 V	2.4		V
		V _{CC} = 5.5 V	4.4		
		V _{CC} = 2 V		0.3	
VIL	V _{IL} Low-level input voltage	V _{CC} = 3 V		0.6	V
		V _{CC} = 5.5 V		1.1	
VI	Input voltage		0	5.5	V
VO	Output voltage		0	VCC	V
		V _{CC} = 2 V		-50	μΑ
loH	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4	m A
		$V_{CC} = 5 V \pm 0.5 V$		-8	mA
		V _{CC} = 2 V		50	μΑ
loL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4	mA
	$V_{CC} = 5 V \pm 0.5 V$			8	IIIA
TA	Operating free-air temperature		-40	85	°C



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T _A = 25°C			MIN	MAX	UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	IVIIIV	WAX	UNIT
		2 V	1.8	2		1.8		
	I _{OH} = -50 μA	3 V	2.7	3		2.7		V
V _{OH}		4.5 V	4	4.5		4		
	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		
		2 V			0.2		0.2	V
	I _{OL} = 50 μA	3 V			0.3		0.3	
V _{OL}		4.5 V			0.5		0.5	
	I _{OL} = 4 mA	3 V			0.36		0.44	
	I _{OL} = 8 mA	4.5 V			0.36		0.44	
lı	V _I = V _{CC} or GND	5.5 V			±0.1		±1	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			1		10	μА
Ci	V _I = V _{CC} or GND	5 V		2	10		10	pF

switching characteristics over recommended operating free-air temperature range, $V_{CC}=$ 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTPUT)	OUTPUT	T _A = 25°C			MIN	MAX	UNIT									
	(INPUT)		(OUTPUT) CAPACITANO	CAPACITANCE	MIN	TYP	MAX	IVIIIV	IVIAA	CINIT								
t _{PLH}	- Α Y C _L = 15 μ	Y	Y	C15 pE		5	7.1	1	8.5	ns								
^t PHL				'	ı	ı	'	'	'	'	'	'	'	'	OL = 15 pr		5	7.1
^t PLH	_	tPLH A	_	V C: 50 75	C 50 pF		7.5	10.6	1	12	no							
t _{PHL}	A	ī	C _L = 50 pF		7.5	10.6	1	12	ns									

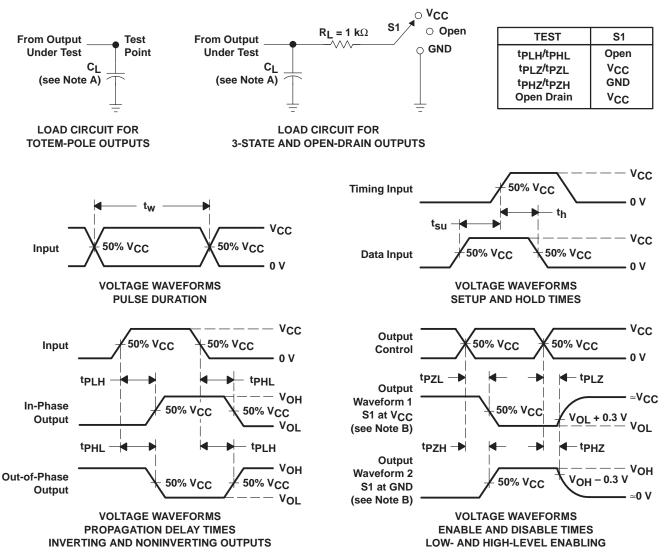
switching characteristics over recommended operating free-air temperature range, $V_{CC}=5~V\pm0.5~V$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	FROM TO	OUTPUT	T _A = 25°C			MIN	MAX	UNIT				
	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	IVIIIN	WAX	UNIT				
tPLH	A	V	V	V	V	V C.	C15 pE		3.5	5.5	1	6	20
tPHL		T	C _L = 15 pF		3.5	5.5	1	6	ns				
tPLH	۸	Y	C50 pF		5	7	1	8	no				
tPHL	A		Ť	l Y	C _L = 50 pF		5	7	1	8	ns		

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER		ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	7.3	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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